

# LM1863

*LM1863 AM Radio System for Electronically Tuned Radios*



Literature Number: SNOSBD6A

# LM1863 AM Radio System for Electronically Tuned Radios

## General Description

The LM1863 is a high performance AM radio system intended primarily for electronically tuned radios. Important to this application is an on-chip stop detector circuit which allows for a user adjustable signal level threshold and center frequency stop window. The IC uses a low phase noise, level-controlled local oscillator.

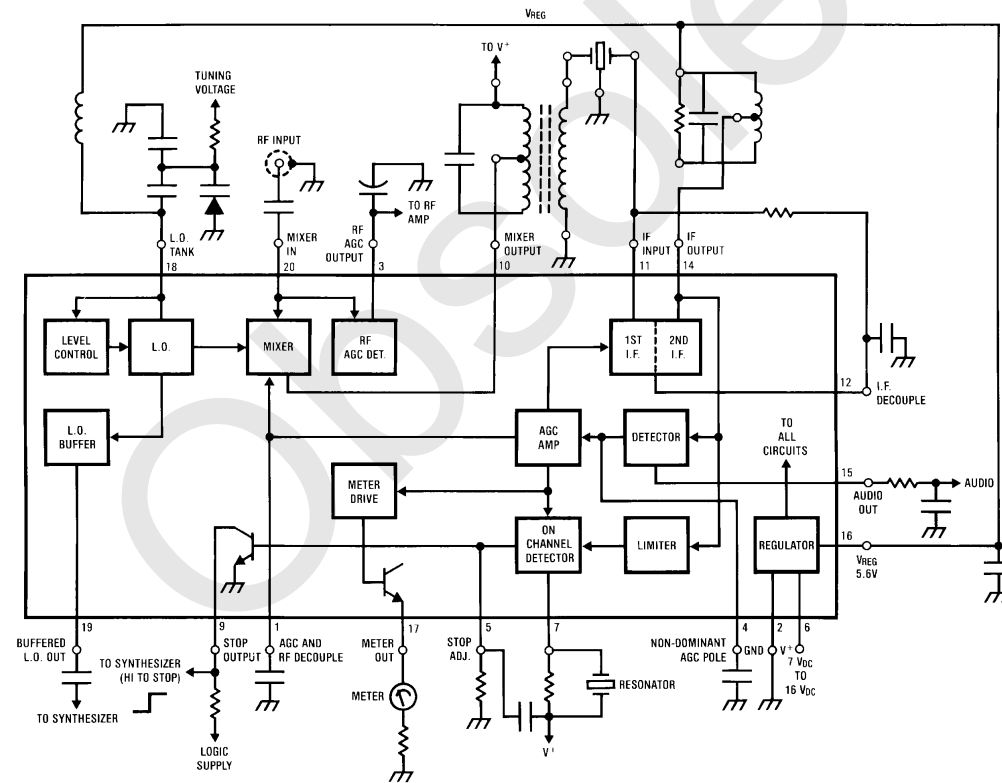
Low phase noise is important for AM stereo which detects phase noise as noise in the L-R channel. A buffered output for the local oscillator allows the IC to directly drive a phase locked loop synthesizer. The IC uses a RF AGC detector to gain reduce an external RF stage thereby preventing overload by strong signals. An improved noise floor and lower THD are achieved through gain reduction of the IF stage. Fast AGC settling time, which is important for accurate stop detection, and excellent THD performance are achieved with the use of a two pole AGC system. Low tweet radiation

and sufficient gain are provided to allow the IC to also be used in conjunction with a loopstick antenna.

## Features

- Low supply current
- Level-controlled, low phase noise local oscillator
- Buffered local oscillator output
- Stop circuitry with adjustable stop threshold and adjustable stop window
- Open collector stop output
- Excellent THD and stop time performance
- Large amount of recovered audio
- RF AGC with open collector output
- Meter output
- Compatible with AM stereo

## Block Diagram



Order Number LM1863M  
See NS Package Number M20B

TL/H/5185-1

LM1863 AM Radio System for Electronically Tuned Radios

## Absolute Maximum Ratings

|                              |                 |                             |              |
|------------------------------|-----------------|-----------------------------|--------------|
| Supply Voltage               | 16V             | Operating Temperature Range | 0°C to +70°C |
| Package Dissipation (Note 1) | 1.7W            | Soldering Information       |              |
| Storage Temperature Range    | -55°C to +150°C | Small Outline Package       |              |
|                              |                 | Vapor Phase (60 sec)        | 215°C        |
|                              |                 | Infrared (15 sec)           | 220°C        |

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

## Electrical Characteristics

(Test Circuit,  $T_A = 25^\circ\text{C}$ ,  $V_+ = 12\text{V}$ , SW1 = Position 1, SW2 = Position 2, unless indicated otherwise)

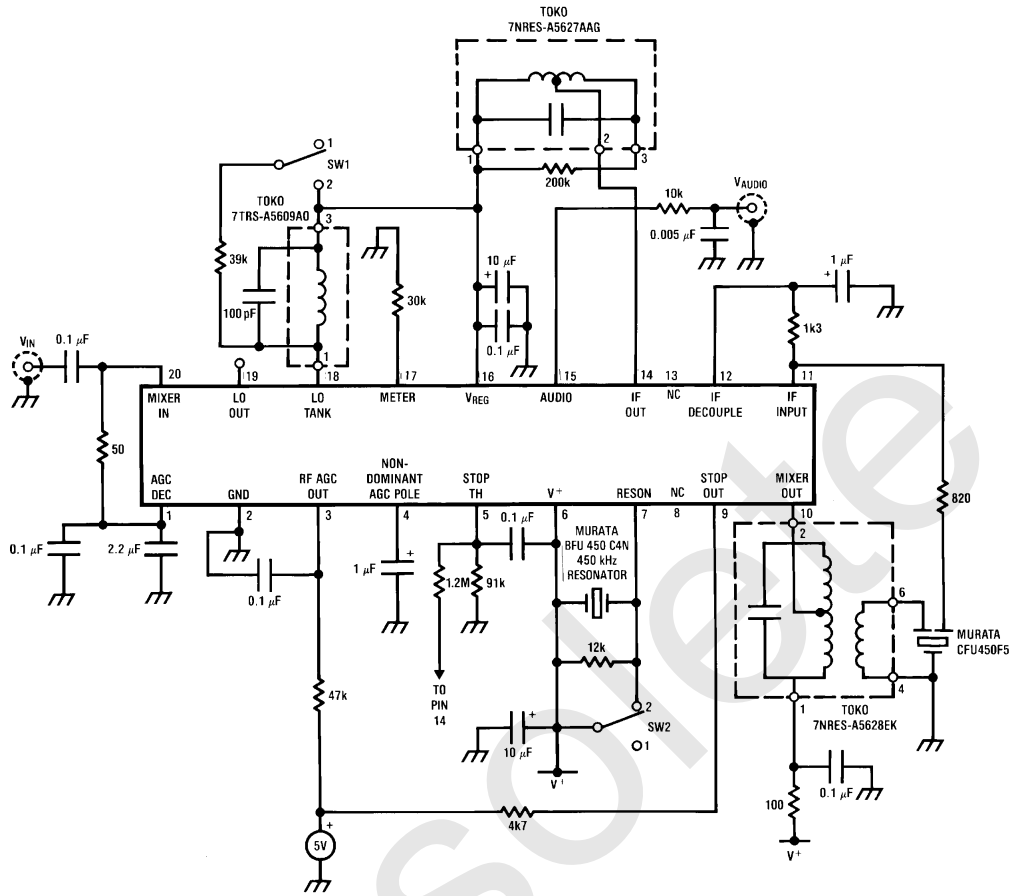
| Parameter   | Conditions   | Min | Typ | Max  | Units            |
|---|--|-----|-----|------|------------------|
| <b>STATIC CHARACTERISTICS</b>   |  |     |     |      |                  |
| Supply Current  | $V_{IN} = 0\text{ mV}$   |     | 8.3 | 12.5 | mA               |
| Pin 16, Regulator Voltage   |  |     | 5.6 |      | V                |
| Operating Voltage Range   | (See Note 2)   | 7   |     | 16   | V                |
| Pin 3 Leakage Current   | $V_{IN} = 0\text{ mV}$   |     | 0.1 |      | $\mu\text{A}$    |
| Pin 9, Low Output Voltage   | $V_{IN} = 0\text{ mV}$ , SW2 = Position 1  |     | .15 |      | V                |
| Pin 17, Output Voltage  | $V_{IN} = 0\text{ mV}$   |     | 0   |      | V                |
| <b>DYNAMIC CHARACTERISTICS: (<math>f_{MOD} = 1\text{ kHz}</math>, <math>f_{IN} = 1\text{ MHz}</math>, <math>M = 0.3</math>)</b> |  |     |     |      |                  |
| Maximum Sensitivity   | $V_{IN}$ For $V_{AUDIO} = 6\text{ mVrms}$  |     | 7.5 |      | $\mu\text{V}$    |
| 20 dB Quieting Sensitivity  | $V_{IN}$ for 20 dB S/N in Audio  |     | 15  | 30   | $\mu\text{V}$    |
| Maximum Signal to Noise Ratio   | $V_{IN} = 10\text{ mV}$  | 40  | 54  |      | dB               |
| Total Harmonic Distortion   | $V_{IN} = 10\text{ mV}$  |     | .26 |      | %                |
| Total Harmonic Distortion   | $V_{IN} = 10\text{ mV}$ , $M = 0.8$  |     | .63 | 2    | %                |
| Audio Output Level  | $V_{IN} = 10\text{ mV}$  | 80  | 120 | 160  | mVrms            |
| Overload Distortion   | $V_{IN} = 50\text{ mV}$ , $M = 0.8$  |     | 7.5 |      | %                |
| Meter Output Voltage  | $V_{IN} = 100\ \mu\text{V}$  |     | 0.5 |      | V                |
| Meter Output Voltage  | $V_{IN} = 10\text{ mV}$  |     | 4.6 |      | V                |
| Local Oscillator Output Level on Pin 19   | (See Note 3), SW1 = Position 1   | 100 | 147 |      | mVrms            |
| Local Oscillator Output Level on Pin 19   | (See Note 3), SW1 = Position 2   |     | 125 |      | mVrms            |
| Stop Detector Valid Station Frequency Window  | $V_{IN} = 10\text{ mV}$ , difference between the two frequencies at which Pin 9 < 1V, SW2 = Position 1 | 2.5 | 4   | 5.5  | kHz              |
| Stop Detector Valid Station Signal Level Threshold  | Find $V_{IN}$ for which Pin 9 > 1V, SW2 = Position 1   | 8   | 16  | 70   | $\mu\text{Vrms}$ |
| RF AGC Threshold  | Find $V_{IN}$ that produces 10 $\mu\text{A}$ of current into Pin 3                                     | 3   | 6   | 10   | mVrms            |
| Pin 3 Low Output Level  | $V_{IN} = 30\text{ mV}$  |     | 0.1 |      | V                |
| Pin 9 Leakage Current   | $V_{IN} = 30\text{ mV}$  |     | 0.1 |      | $\mu\text{A}$    |
| Pin 17 Output Resistance  | $V_{IN} = 10\text{ mV}$  |     | 825 |      | $\Omega$         |

**Note 1:** Above  $T_A = 25^\circ\text{C}$  derate based on  $T_J(\text{MAX}) = 150^\circ\text{C}$  and  $\theta_{JA} = 85^\circ\text{C/W}$ .

**Note 2:** All data sheet specifications are for  $V_+ = 12\text{V}$  and may change slightly with supply.

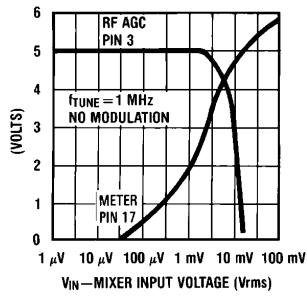
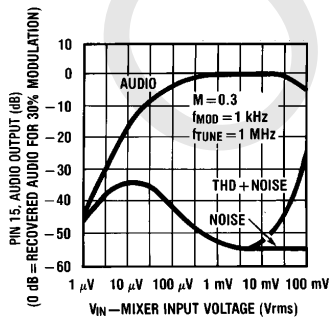
**Note 3:** The local oscillator level at Pin 19 is identical to the level at Pin 18 since Pin 19 is an emitter follower off of Pin 18.

## Test Circuit

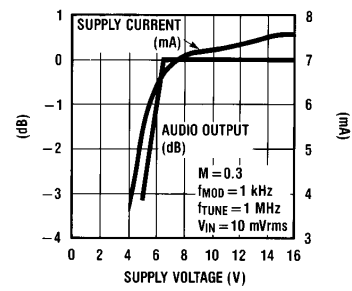


TL/H/5185-2

## Typical Performance Characteristics (From Test Circuit)



TL/H/5185-9

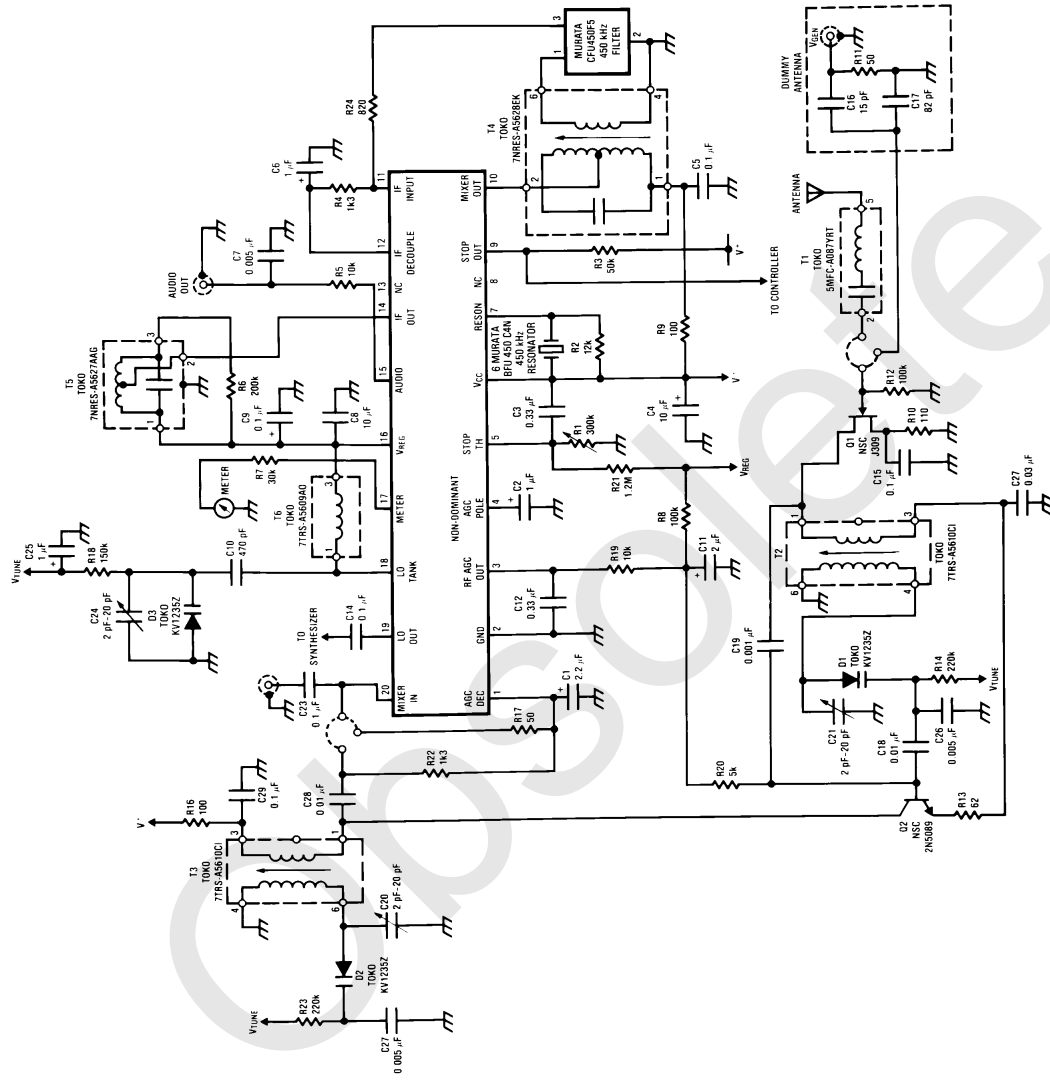


TL/H/5185-10

TL/H/5185-11

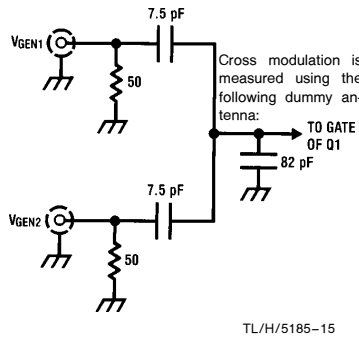
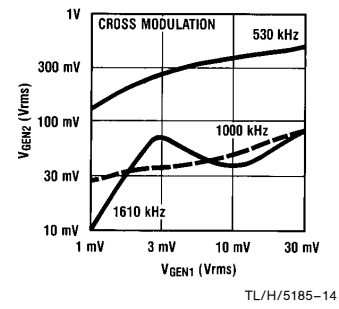
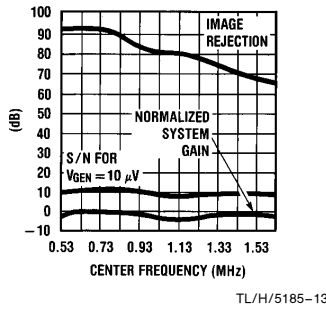
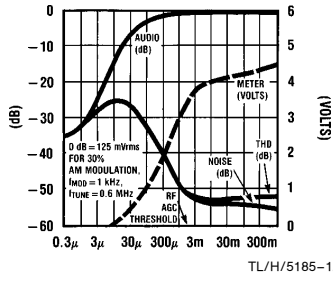
# Application Circuit

LM1863: AM ETR Radio



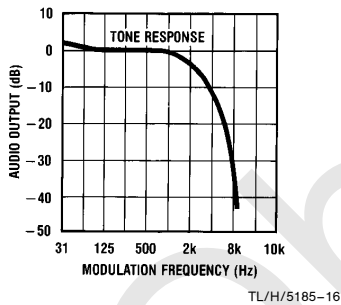
TL/H/5185-8

# Performance Characteristics of Applications Circuit



The following procedure was used to measure cross modulation:

1. Tune the radio to the center frequency of interest and tune  $V_{GEN1}$  to this same frequency.
2. Set at 0 dB audio reference with  $V_{GEN1} = 10$  mV RMS and 30% AM mod;  $f_{MOD} = 1$  kHz.
3. Remove the modulation from  $V_{GEN1}$  and set the level of  $V_{GEN1}$ .
4. Set the modulation level of  $V_{GEN2} = 80\%$  at  $f_{MOD} = 1$  kHz and tune  $V_{GEN2} \pm 40$  kHz away from center frequency.
5. Increase the level of  $V_{GEN2}$  until  $-40$  dB of audio is recovered. The level of  $V_{GEN2}$  is the cross modulation measurement.



Additional Performance Information:

- \* THD for 80% modulation for  $f_{MOD} = 1$  kHz at:  
 $V_{GEN} = 1V$  is 0.5%  
 $V_{GEN} = 10$  mV is 0.4%
- \* Tweet < 2% at all input levels.
- \* Typical time for valid stop indication < 50 ms.

**Note:** Tweet is an audio tone produced by the 2nd and 3rd harmonic of the IF beating against the received signal. It is measured as an equivalent modulation level: ie, 30% tweet has the same amplitude at the detector as a desired signal with 30% modulation.

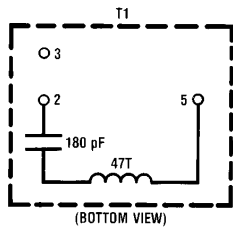
## IC External Components (See Application Circuit)

| Component   | Typical Value                             | Comments   |
|-------------|---|--|
| C1          | 2.2 $\mu$ F                               | Sets dominant AGC pole, affects stop time and THD.   |
| C2          | 1 $\mu$ F                                 | Sets non-dominant AGC pole, affects stop time and THD.   |
| C3          | 0.33 $\mu$ F                              | Stop level threshold decoupling, affects stop time and sensitivity of stop detector to large modulation peaks.   |
| C4          | 10 $\mu$ F                                | Supply decoupling, low frequency.  |
| C5          | 0.1 $\mu$ F                               | Supply decoupling, high frequency.   |
| C6          | 1 $\mu$ F                                 | IF decouple, affects IF gain.  |
| C7          | 0.005 $\mu$ F                             | Audio output filter, removes IF ripple from detector.  |
| C8          | 10 $\mu$ F                                | Regulator decouple, low frequency.   |
| C9          | 0.1 $\mu$ F                               | Regulator decouple, high frequency.  |
| C10         | 470 pF                                    | Pad capacitor for varactor, affects tracking.  |
| C11         | 2 $\mu$ F                                 | RF AGC decouple, affects stop time and THD.  |
| C12         | 0.33 $\mu$ F                              | RF AGC high frequency decouple.  |
| C14         | 0.1 $\mu$ F                               | Local oscillator output coupling.  |
| C19         | 0.001 $\mu$ F                             | Sets gain at high end of AM band.  |
| C26         | 0.005 $\mu$ F                             | Sets gain at low end of AM band.   |
| C28         | 0.01 $\mu$ F                              | Couples RF stage output to mixer input, keep small to insure proper stop time performance when RF AGC is active. |
| R1          | 300k Pot.                                 | Sets level stop threshold.   |
| R2          | 12k                                       | Sets size of stop window.  |
| R3          | 50k                                       | Open collector pull up resistor.   |
| R4          | 1k $\Omega$                               | IF filter termination, and gain set.   |
| R5          | 10k                                       | Sets RC time constant on audio outputs, smaller values may cause distortion of high frequencies.                 |
| R6          | 200k                                      | Sets gain of IF stage, affects noise floor and sensitivity.  |
| R7          | Meter Dependent                           | Sets full-scale deflection of meter.   |
| R8          | 100k                                      | Sets gain and threshold of RF AGC.   |
| R9          | 100 $\Omega$                              | Aids mixer output decoupling.  |
| R19         | 10k                                       | Sets 2 <sup>nd</sup> pole in RF AGC, affects THD for large input signals.  |
| R21         | 1.2 M $\Omega$                            | Biases pin 5 to 0.4 volts which permits shorter stop time.   |
| R24         | 820 $\Omega$                              | Sets system gain.  |
| D1, D2, D3, | TOKO<br>KV1235Z or<br>Equivalent          | Varactor diodes.   |
| Resonator   | 450 kHz $\pm$ 1 kHz<br>Murata*, BFU450C4N | Parallel type resonator.   |
| IF filter   | Murata*<br>CFU450F5                       | Sets selectivity and tone response.  |

\*Murata  
2200 Lake Park Drive  
Smyrna, GA 30080  
(404) 436-1300

## Performance Characteristics of Applications Circuit (Continued)

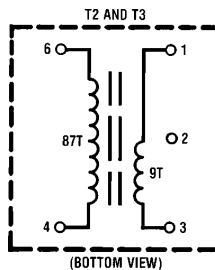
**Part No. 5MFC-A087YRT  
TOKO**



TL/H/5185-17

Center Frequency = 2 MHz  
 $Q_u > 50$  at 2 MHz

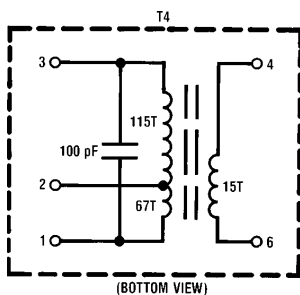
**Part No. 7TRS-A5610CI  
TOKO**



TL/H/5185-18

$Q_u > 95$  at 1 MHz  
 $L_{4-6} = 200 \mu\text{H}$

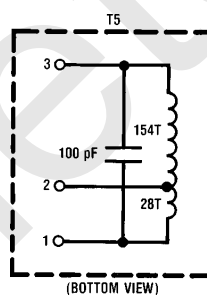
**Part No. 7NRES-A5628EK  
TOKO**



TL/H/5185-19

Center Frequency = 450 kHz  
 $Q_u > 100$  at 450 kHz

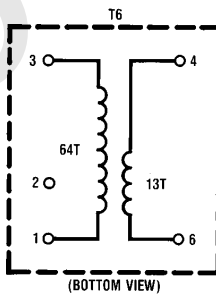
**Part No. 7NRES-A5627AAG  
TOKO**



TL/H/5185-20

Center Frequency = 450 kHz  
 $Q_u > 100$  at 450 kHz

**Part No. 7TRS-A5609A0  
TOKO**



TL/H/5185-21

Center Frequency = 1 MHz  
 $Q_u > 95$  at 1 MHz  
 $L_{1-3} = 110 \mu\text{H}$

\*Toko America  
 1250 Feehanville Drive  
 Mount Prospect, IL 60056  
 (312) 297-0070



## Layout Considerations

Although the pinout of the LM1863 has been chosen to minimize layout problems, some care is required to insure proper performance. If the LM1863 is used with a loopstick antenna, care in the placement of C3 must be observed in order to minimize tweet radiation. Orient C3 parallel to the axis of the loopstick and as far away as possible. Keep C3 close to the IC. The ground on C6 should be located near the ground terminal of the 450 kHz ceramic filter. C11 should be located near Q2 and C12 should be located near the IC. Also, the resonator on Pin 7 and resistor R2 should be located near the IC in order to minimize tweet radiation.

The mixer output, Pin 10 and the IF input, Pin 11, traces should be as short as possible to prevent stray pick up from the resonator.

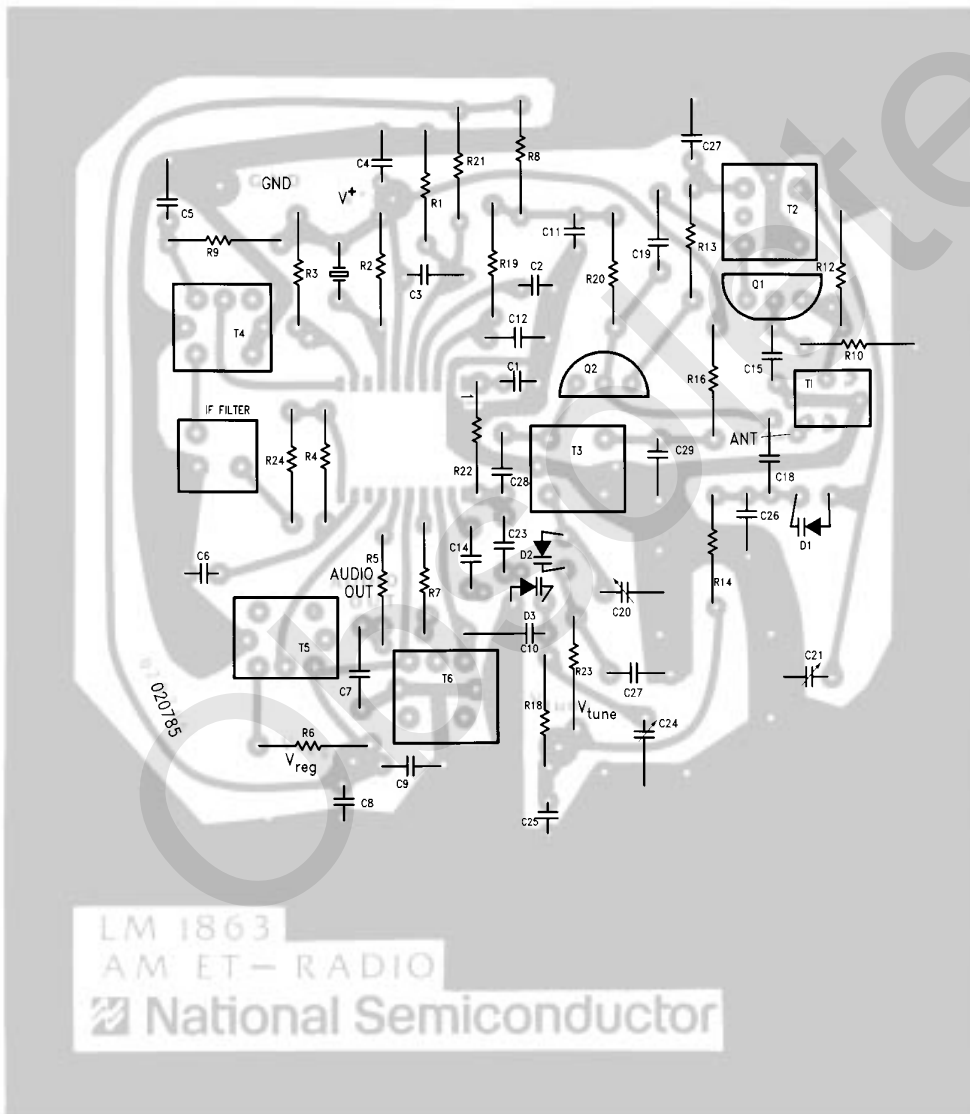
## Applications Information

(See typical application and LM1863 schematic diagram.)

### STOP DETECTOR

There are two criteria that determine when an electronically tuned radio is tuned to a valid station. The first criterion is that the incoming signal be of sufficient strength to be listenable. The second criterion requires that the radio be tuned

PC Layout (Component Side)



TL/H/5185-22

## Applications Information (Continued)

to the center frequency of the incoming station. Both the signal strength threshold and the center tune window are externally adjustable.

The signal strength threshold is set by resistor R1. Increasing the value of this resistor will reduce the signal level threshold. There is no difficulty in setting the signal strength threshold, either above or below the AGC threshold.

Resistor R2 sets the center tune window. The incoming station is considered to be center tuned whenever the frequency of the signal at the IF output falls within the center tune window. Increasing the value of R2 will narrow the window, while decreasing R2 will widen the window. Since there is some interaction between R2 and R1, R2 should be chosen before R1. In the United States, stations within the AM band are spaced no closer than 10 kHz apart. Consequently, the controller should be set up to stop every 10 kHz within the AM band when the ETR is in scan mode. A center tune window anywhere less than  $\pm 10$  kHz is therefore adequate in determining the center tune condition, though a narrower stop window is desirable in order to minimize the chance that side bands from a strong adjacent channel will fall within the stop window.

Because of asymmetry in the resonator amplitude characteristic, the center tune stop window will not be symmetric about the center frequency of the resonator. This is not a problem as long as the stop window brackets the center frequency of the IF and does not extend into the next channel. However, in order to avoid any problems in this regard it is recommended that the resonator center frequency deviate no more than  $\pm 1$  kHz from the center frequency of the IF.

The stop output, Pin 9, is an open collector NPN transistor. This output must be taken to a positive voltage through a load resistor, R3. A valid stop condition is indicated by a high output level on Pin 9 (i.e., the NPN is turned off). The voltage on this pin should not exceed 16 volts.

### STOP DETECTOR STOP TIME

The amount of time required for the LM1863 to output an accurate stop indication on Pin 9 is defined as the stop time. The stop time determines how quickly the ETR can scan across the AM band. There are several factors that influence the stop time. Since the signal level stop function operates in conjunction with the Automatic Gain Control (AGC), the AGC settling time is a critical factor. This settling time is dominated by the low frequency AGC pole which is set by C1 and internal IC resistances. Decreasing C1 will decrease the AGC settling time but increase total harmonic distortion, THD, of the recovered audio. A good compromise between AGC settling time and THD is very difficult to reach with a single pole AGC system. Consequently, the LM1863 has been designed with a second, higher frequency, AGC pole. This non-dominant pole is externally set by capacitor C2. As a result, C1 can be made much smaller than it otherwise could for an equivalent amount of THD. Reducing C1 will reduce the stop time. The combination of C1 and C2 as shown in the applications circuit results in a stop time of less than 50 ms for most input conditions, while at the same time the circuit achieves .9% THD at 80% modulation with 400 Hz modulation frequency at 10 mV input signal strength. Had C2 not been present the stop time would still be 50 ms but the THD for similar input conditions would be 8%. By decreasing both C1 and C2 (keeping the ratio of C1/C2 constant) the stop time can be reduced at the expense of THD, while the converse is also true.

The addition of a second pole to the AGC response does add some ringing to the AGC voltage following signal transients. The frequency, duration and amount of ringing are dependent on where both AGC poles are placed and to some extent the input signal conditions. The amount of ringing should be kept to a minimum in order to insure proper stop indications. The amount of ringing can be reduced by either reducing C2 (this will increase THD) or by increasing C1 (this will improve THD but increase stop time).

If the ratio of C1/C2 is made too small, an increase in low frequency noise may be noticed resulting from the peaking that a closed loop two pole system exhibits near the unity gain frequency. The extent of this peaking can be observed by examining the amount of recovered audio at various low frequency modulations. In general, the values shown reach a good compromise between THD, stop time, ringing and low frequency noise.

The center tuning detector on the LM1863 passes the signal at the IF output through a limiting amplifier which removes most of the modulation from the IF waveform. The output of this limiter is then applied to the resonator on Pin 7. Unfortunately, large modulation peaks are not completely removed by the limiting amplifier. Without C3, these large modulation peaks would cause glitches on the stop output when the LM1863 was tuned to a valid station. C3 acts to reduce these glitches by filtering the output of the center tune circuit. C3, however, also affects the stop time and cannot be made arbitrarily large. A time constant of about 30 ms on Pin 5 gives the best compromise. R21 biases Pin 5 to about .4 volts, which is below the stop threshold at this point. This biasing results in a shorter stop time.

Extra precaution can be taken within the software of the controller IC to further insure accurate stop detector performance over a wide variety of input signal conditions. A typical controller IC stop algorithm is as follows:

The controller waits the first 10 ms after the LM1863 is tuned to the next channel. The controller then samples the LM1863 stop output 10 times within the next 40 ms. If no high output is sensed within that time the controller concludes there is no valid station at the frequency and moves to the next channel. If, however, at least one high output is detected within the first 50 ms the controller waits an additional 200 ms and at the end of that time re-samples the stop output in order to make its final stop determination.

### RF AGC

The RF AGC detector is designed to control the gain of an external RF amplifier which is placed between the antenna and the mixer input. The RF AGC operates by detecting when the input signal to the mixer reaches 6 mVrms, the RF AGC threshold. When the mixer input signal reaches this level the RF AGC is activated and will hold the mixer input level relatively constant at the level of the RF AGC threshold. The gain of the RF AGC determines how constant the RF AGC can control the RF output. The LM1863 RF AGC is high gain and consequently the RF AGC output, Pin 3, will transition from high to low over a very narrow input range to the mixer when the LM1863 is examined in an OPEN LOOP condition. However, in a radio where the RF AGC controls the RF gain, a CLOSED LOOP negative feedback system is established. In this application the RF AGC output will transition from high to low over a large range of signal levels to the input of the RF stage.

## Applications Information (Continued)

The RF AGC threshold has been carefully chosen to prevent overloading the mixer, which would cause distortion and tweet problems. However, the threshold level is sufficiently large to minimize the possibility of strong adjacent stations de-sensitizing the radio by activating the RF AGC and thereby gain reducing the RF front end.

The RF AGC output, Pin 3, is an open collector NPN transistor. This collector must be tied to a positive voltage through a load resistor, R8. Furthermore, decoupling is required (C11 and C12) in order to insure that the RF AGC does not induce significant distortion in the recovered audio. However, the tradeoff between good THD performance and fast stop time is not too severe for the RF AGC because large changes in the RF AGC level are unlikely when moving between adjacent channels. This is because the selectivity in the RF stage is not great enough to cause abrupt signal level changes at the mixer input as the radio is tuned. Thus, since the RF AGC does not have to follow abrupt signal level changes, the time constant on the AGC output can be relatively long which allows for good THD performance. C12 is required in order to insure good RF decoupling of signals at the RF AGC output, and sets the non-dominant pole.

The RF AGC 10  $\mu$ A threshold is fixed at 6 mVrms at the mixer input. However, due to the gain of the RF stage and losses through the RF transformers, this level may be different when referenced to the antenna input. For the application circuit shown the RF threshold occurs at 2 mVrms at the dummy antenna input. Thus, the RF AGC threshold can effectively be adjusted by altering the gain of the RF stage. The value of R8 also has some affect on the RF AGC threshold of the application circuit. Smaller values will tend to increase the threshold while larger values will tend to reduce the threshold.

### GAIN DISTRIBUTION

The purpose of this section is to clarify some of the tradeoffs involved in redistributing gain from one portion of the radio to another. An AM radio basically has three gain blocks consisting of the RF stage, the mixer, and the IF stage. The total gain of these three blocks must be sufficiently large as to insure reception of weak stations. Given then a fixed amount of required gain how does distributing this gain among the three blocks affect the radio performance?

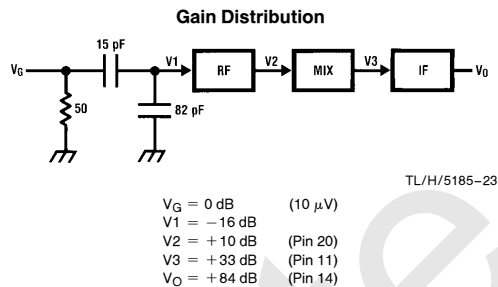
Large amounts of gain in the RF stage will have the effect of decreasing the RF AGC threshold. A decreased RF AGC threshold means that it is more likely that strong adjacent stations can activate the RF AGC and desensitize the radio. Also, a lot of RF gain implies large signals across the RF varactor diodes, which is undesirable for good tracking and can result in overloading these varactors which can cause cross modulation. On the other hand, high RF gain insures good noise performance and improved THD.

High mixer gain implies large signal swings at the mixer output, especially on AGC transients. These large signal swings could cause the mixer output transistors to saturate and also could overload the IF stage. On the other hand, redistributing the gain from the IF to the mixer would improve the noise performance of the radio. The gain of the mixer can be controlled moving the tap on the mixer output transformer, T4.

Since the output signal level of the IF is held constant by the AGC, increasing gain in the IF has the effect of reducing the

signal level at the IF input. Noise sources at the IF input therefore become a larger percentage of the IF input signal thereby degrading the S/N floor of the radio. For this reason, the LM1863 employs 20 dB of IF AGC. The IF gain of the LM1863 is adjustable by changing the tap across the IF output coil, or by changing the ratio of R24 to R4.

The gain distribution for the application circuit is as follows:



The IF gain could also be varied by changing the value of R6 across the IF output coil. However, it is a good idea to maintain a high Q IF tank in order to achieve good adjacent channel rejection. In order to prevent distortion due to overloading the IF amplifier, it is important that the impedance Pin 14 sees looking into the IF output tank, T5, does not go below 3K ohms.

The above gain distribution is prior to any AGC action in the radio. This distribution represents a good compromise between the various tradeoffs outlined previously.

### LEVEL CONTROLLED LOCAL OSCILLATOR

Tracking of the RF varactors with the local oscillator varactor is a serious consideration in order to insure adequate performance of the ETR radio. Due to non-linear capacitance versus voltage characteristic of the varactor, large signals across these varactors will tend to modulate their capacitance and cause tracking problems. This problem is compounded further if the level of the signals across the varactors change. In an AM radio, the local oscillator frequency changes a ratio of two to one. The Q of the oscillator tank remains fairly constant over this range. Thus, since  $Q = R_p/\omega L = \text{Constant}$ , this implies that  $R_p$  ( $R_p =$  unloaded parallel resistance of the tank) must change two to one. The internal level-control loop prevents the two to one change in AC voltage across the tank which the change in the  $R_p$  would otherwise cause.

Phase jitter of the local oscillator is very important in regard to AM stereo, where L-R information is contained in the phase of the carrier. Local oscillator jitter has the effect of modulating the L-R channel with phase noise, thus degrading the stereo signal to noise performance. Great care has been taken in the design of the LM1863 local oscillator to insure that phase jitter is a minimum. In fact the dominant source of phase jitter is the high impedance resistor drive to the varactor. The thermal noise of the resistor modulates the varactor voltage, thus causing phase jitter.

### VARACTOR TUNED RF STAGE

Electronically tuned car radios require the use of a tuned RF stage prior to the mixer. Many of the performance charac-

## Applications Information (Continued)

teristics of the radio are determined by the design of this stage. Generally speaking it is very difficult to design an integrated RF stage in bipolar, as bipolar transistors do not have good overload characteristics. Thus, the RF stage is usually designed using discrete components. Because of this there is a great deal of concern with minimizing the number of discrete components without severely sacrificing performance. The applications circuit RF stage does just this.

The circuit consists of only two active devices, an N-channel JFET, Q1, which is connected in a cascode type of configuration with an NPN BJT, Q2. Both Q1 and Q2 are varactor tuned gain stages. Q2 also serves to gain reduce Q1 when Q2's base is pulled low by the RF AGC circuit on the LM1863. The gain reduction occurs because Q1 is driven into a low gain resistive region as its drain voltage is reduced. R10 and C15 set the gain of the 1'st RF stage which is kept high (about 19 dB) for good low signal, signal/noise performance. The gain of the front end to the mixer input referenced to the generator output is about +10 dB.

T2 in conjunction with D1, C21 and C26 form the 1'st tuned circuit. C26 does not completely de-couple the RF signal at the cathode of the varactor. In fact, the combination of C26 and C19 act to keep the gain of the whole RF stage constant over the entire AM band. Without special care in this regard the gain variation could be as high as 14 dB. This gain variation would result from the increase in impedance at the secondary's of T2 and T1 as the tuned frequency is increased. The increased impedance results from a constant  $Q = R_p / (wL)$  of the tanks over the AM band. With C26 and C19 the gain is held constant to within 6 dB (including the tracking error) over the entire AM band.

C27 de-couples RF signal from the top of T2's primary and allows Q2 to operate properly. C18 is a coupling capacitor which in conjunction with C19 couples the signal from the 1'st RF stage to the 2'nd RF stage. R20 acts to isolate this signal from AC ground at C11. R19 acts in conjunction with C12 to set a high frequency (ie: non-dominant) RF AGC pole which is important for low distortion when the RF AGC is active. The dominant RF AGC pole is set by R8 and C11. Q2 is a high beta transistor allowing for little voltage drop across R20 and R8 due to base current. This keeps the emitter of Q2 sufficiently high (in the absence of RF AGC) to bias Q1 in its square law region.

R13 acts to reduce the 2'nd stage gain and increase Q2's signal handling. R13 must not get too large, however, (ie:  $R13 > 100 \Omega$ ), or low level signal/noise will be degraded. T3 in conjunction with C20, C27 and D2 form the 2'nd RF tuned circuit. The output of Q2 is capacitively coupled through C28 to the mixer input. The output of Q2 is loaded not only by the reflected secondary impedance but also by R22. R22 is carefully chosen to load the 2'nd stage tuned circuit and broaden its bandwidth. The increased bandwidth of the 2'nd stage greatly improves the cross modulation performance of the front end. In the absence of this increased bandwidth, the relatively large AC signals across varactor D2 result in cross modulation. R22 also reduces the total gain of the 2'nd stage. R22 does slightly degrade (by about 6 dB) the image rejection especially at the high end of the AM band. However, the image rejection of this front end is still excellent and 6 dB is a small price to pay for the greatly increased immunity to cross modulation.

R16 and C29 decouple unwanted signals on V+ from being coupled into the RF stage. This front end also offers superi-

or performance with respect to varactor overload by strong adjacent channels. This results because of the way that gain has been distributed between the 1'st and 2'nd stages.

In summary, this front end offers two stages of RF gain with the 2'nd stage acting to gain reduce the 1'st stage when RF AGC is active. Furthermore, a unique coupling scheme is employed from the output of the 1'st stage to the input of the 2'nd stage. This coupling scheme equalizes the gain from one end of the AM band to the other. Additional care has been taken to insure that excellent cross modulation performance, image rejection, signal to noise performance, overload performance, and low distortion are achieved. Performance characteristics for this front end in conjunction with the LM1863 are shown in the data sheet. Also, information with regard to the bandwidth of the front end versus tuned frequency are given below.

| TUNED FREQUENCY | - 3 dB BANDWIDTH |
|-----------------|------------------|
| 530 kHz         | 6.6 kHz          |
| 600 kHz         | 7.2 kHz          |
| 1200 kHz        | 20.6 kHz         |
| 1500 kHz        | 26.4 kHz         |
| 1630 kHz        | 36 kHz           |

### VARACTOR ALIGNMENT PROCEDURE

The following is a procedure which will allow you to properly align the RF and local oscillator trim capacitors and coils to insure proper tracking across the AM band.

1. Set the voltage across the varactors = 1 volt.
2. Set the trimmers to 50%.
3. Adjust the oscillator coil until the local oscillator is at 980 kHz.
4. Increase the varactor voltage until the local oscillator (L0) is at 2060 kHz and check to see if this voltage is less than 9.5 volts but greater than 7.5 volts. If it is then the L0 is aligned. If it is not then adjust the L0 coil/trimmer until the varactor voltage falls in this range.
5. Set the RF in to 600 kHz and adjust the tuning voltage until the L0 is at 1050 kHz. Peak all RF coils for maximum recovered audio at low input levels.
6. Set RF in to 1500 kHz and adjust the tuning voltage until the L0 is at 1950 kHz. Peak all RF trim capacitors for maximum recovered audio at low input levels.
7. Go back to step 5 and iterate for best adjustment.
8. Check the radio gain at 530 kHz and 750 kHz to make sure that the gain is about the same at these two frequencies. If it is not, then slightly adjust the RF coils until it is.

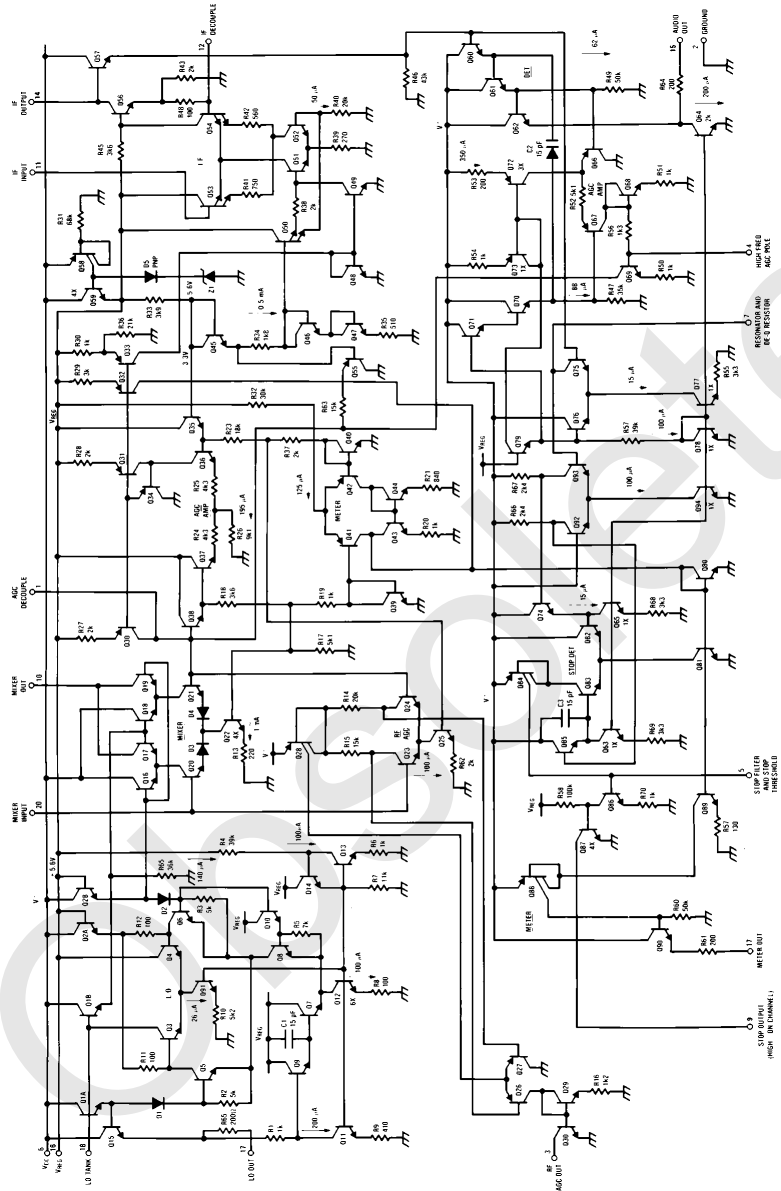
The above procedure will insure perfect tracking at 600 kHz, 950 kHz and 1500 kHz. The amount of gain variation across the AM band using the above procedure should not exceed 6 dB.

### ADDITIONAL INFORMATION

R5 and C7 act as a low pass filter to remove most of the residual 450 kHz IF signal from the audio output. Some residual 450 kHz signal is still present, however, and may need to be further removed prior to audio amplification. This need becomes more important when the LM1863 is used in conjunction with a loopstick antenna which might pick up an amplified 450 kHz signal. An additional pole can be added to the audio output after R5 and C7 prior to audio amplification if further reduction of the 450 kHz component is required.

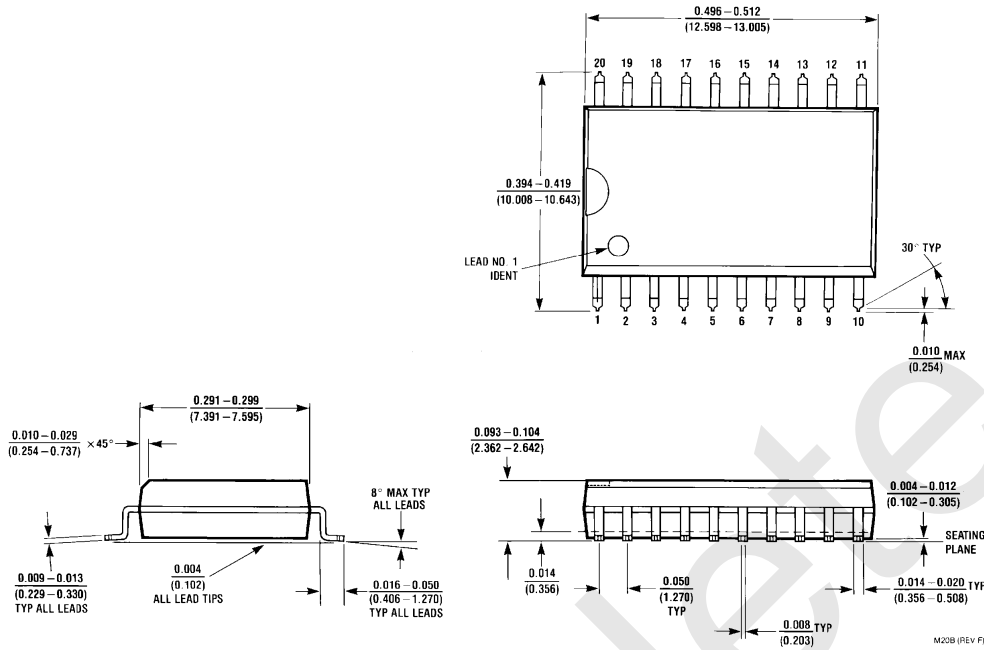
# Equivalent Schematic Diagram

TL/H/5185-24



Obsolete

**Physical Dimensions** inches (millimeters)



**Plastic Small Outline Package (M)**  
**Order Number LM1863M**  
**NS Package Number M20B**

**LIFE SUPPORT POLICY**

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



**National Semiconductor Corporation**  
 1111 West Bardin Road  
 Arlington, TX 76017  
 Tel: 1(800) 272-9959  
 Fax: 1(800) 737-7018

**National Semiconductor Europe**  
 Fax: (+49) 0-180-530 85 86  
 Email: cnjwge@tevm2.nsc.com  
 Deutsch Tel: (+49) 0-180-530 85 85  
 English Tel: (+49) 0-180-532 78 32  
 Français Tel: (+49) 0-180-532 93 58  
 Italiano Tel: (+49) 0-180-534 16 80

**National Semiconductor Hong Kong Ltd.**  
 19th Floor, Straight Block,  
 Ocean Centre, 5 Canton Rd.  
 Tsimshatsui, Kowloon  
 Hong Kong  
 Tel: (852) 2737-1600  
 Fax: (852) 2736-9960

**National Semiconductor Japan Ltd.**  
 Tel: 81-043-299-2309  
 Fax: 81-043-299-2408

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

### Products

|                        |  |
|------------------------|--|
| Audio                  | <a href="http://www.ti.com/audio">www.ti.com/audio</a>                               |
| Amplifiers             | <a href="http://amplifier.ti.com">amplifier.ti.com</a>                               |
| Data Converters        | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>                       |
| DLP® Products          | <a href="http://www.dlp.com">www.dlp.com</a>   |
| DSP                    | <a href="http://dsp.ti.com">dsp.ti.com</a>   |
| Clocks and Timers      | <a href="http://www.ti.com/clocks">www.ti.com/clocks</a>                             |
| Interface              | <a href="http://interface.ti.com">interface.ti.com</a>                               |
| Logic                  | <a href="http://logic.ti.com">logic.ti.com</a>                                       |
| Power Mgmt             | <a href="http://power.ti.com">power.ti.com</a>                                       |
| Microcontrollers       | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a>                   |
| RFID                   | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>                                 |
| OMAP Mobile Processors | <a href="http://www.ti.com/omap">www.ti.com/omap</a>                                 |
| Wireless Connectivity  | <a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a> |

### Applications

|                               |  |
|-------------------------------|--|
| Communications and Telecom    | <a href="http://www.ti.com/communications">www.ti.com/communications</a>                 |
| Computers and Peripherals     | <a href="http://www.ti.com/computers">www.ti.com/computers</a>                           |
| Consumer Electronics          | <a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>                   |
| Energy and Lighting           | <a href="http://www.ti.com/energy">www.ti.com/energy</a>                                 |
| Industrial                    | <a href="http://www.ti.com/industrial">www.ti.com/industrial</a>                         |
| Medical                       | <a href="http://www.ti.com/medical">www.ti.com/medical</a>                               |
| Security                      | <a href="http://www.ti.com/security">www.ti.com/security</a>                             |
| Space, Avionics and Defense   | <a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a> |
| Transportation and Automotive | <a href="http://www.ti.com/automotive">www.ti.com/automotive</a>                         |
| Video and Imaging             | <a href="http://www.ti.com/video">www.ti.com/video</a>                                   |

TI E2E Community Home Page

[e2e.ti.com](http://e2e.ti.com)

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2011, Texas Instruments Incorporated